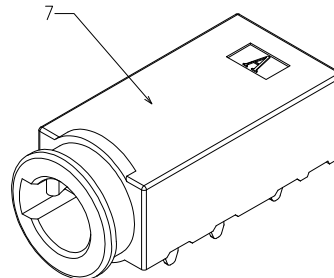
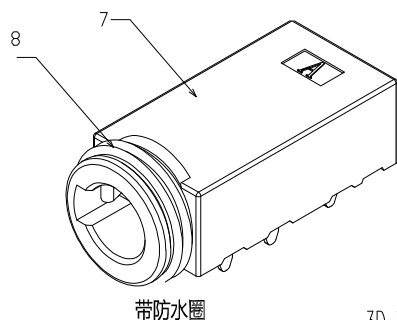
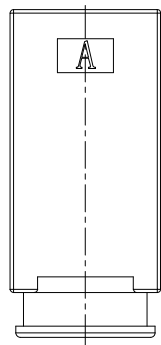


RoHS
Compliant

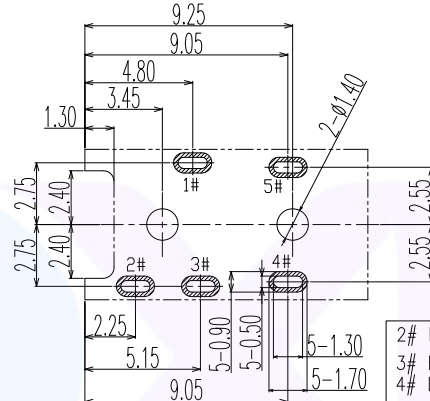
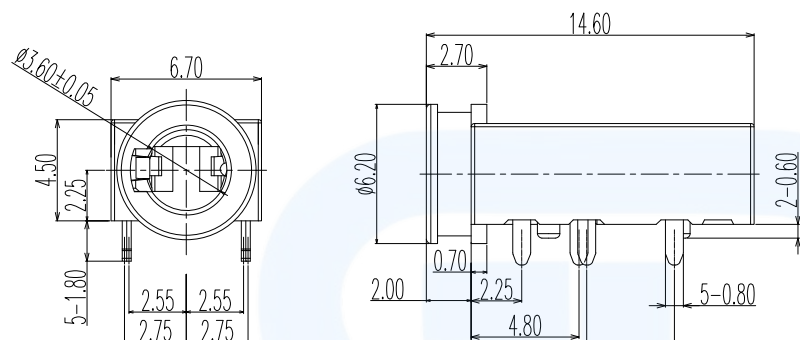
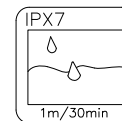


3D VIEW

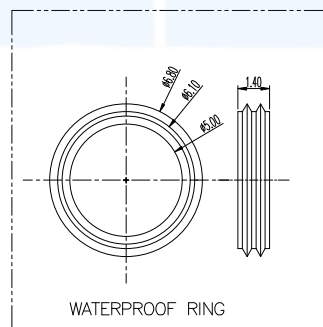
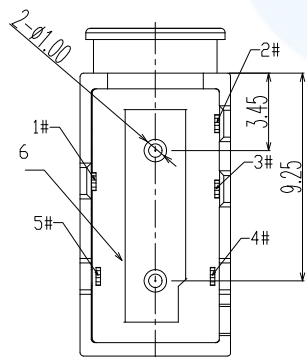
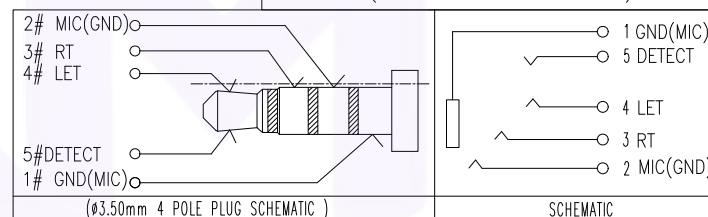
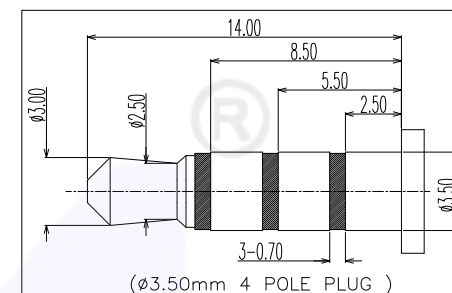
不带防水圈

带防水圈

1. CONTACT CURRENT RATING: 1A.
2. CONTACT RESISTANCE: 100 mΩ MAX.;
3. INSULATION RESISTANCE: 100Ω MIN.;
4. DIELECTRIC WITHSTANDING: 500V AC MIN.;
5. DURABILITY: 5,000 CYCLES MIN.;
6. CONNECTOR MATING FORCES: 30N MAX.;
7. CONNECTOR UNMATING FORCES: 3N MIN.;
8. TERPROOF LEVEL: IP67;



P.C.B LAYOUT T=1.00mm
TOP VIEW



8	WATERPROOF RING	1	SILICA GEL	
7	HOUSING	1	HIGH TEMPERATURE PLASTIC MATERIALE; COLOR BLACK	
6	COVER	1	HIGH TEMPERATURE PLASTIC MATERIALE; COLOR BLACK	
5	TERMINAL 5#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
4	TERMINAL 4#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
3	TERMINAL 3#	1	PHOSPHOR BRONZE; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
2	TERMINAL 2#	1	PHOSPHOR BRONZE; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
1	TERMINAL 1#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
ITEM	NAME	Q'TY	DESCRIPTION	NOTE

广东小迈实业有限公司

Website:

<https://www.xmconn.com>

TEL:

18938295888



PART NAME

Ø3.5 WATERPROOF PHONE JACK CONNECTOR

PART NO.

DM35A034-05DP-E

TOLERANCE UNLESS
OTHERWISE SPECIFIED:

X ±0.2
X.X ±0.15
X.XX ±0.10
X.XXX ±0.050

DRAWING:

Li

DATE:

2023.08.18

SCALE

SHEET

REV: A0

CHECK:

Chen

DATE:

2023.08.18

1:1

1/1

SIZE: A4

APPROVAL:

Wen

DATE:

2023.08.18

